

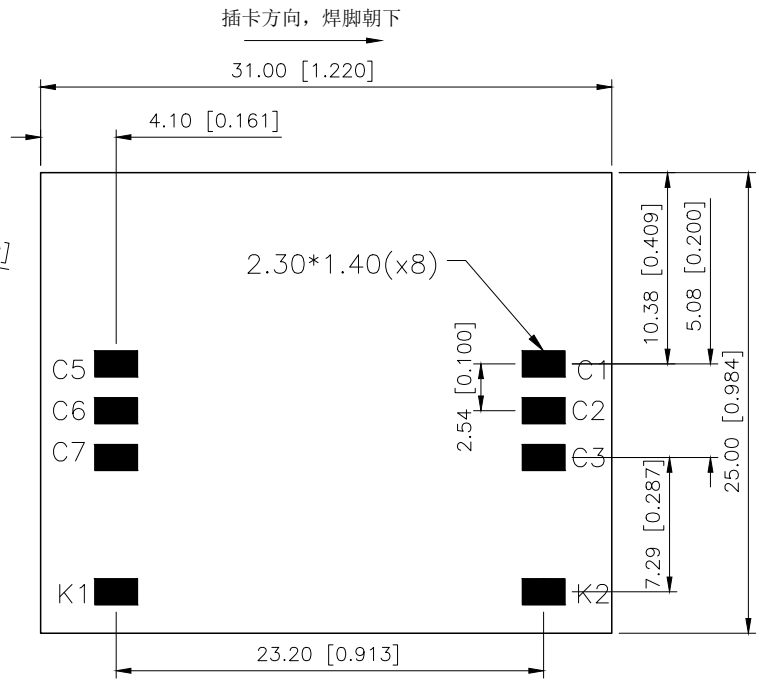
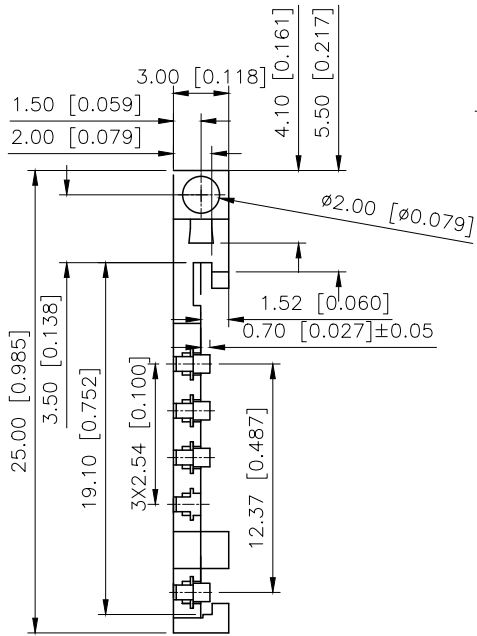
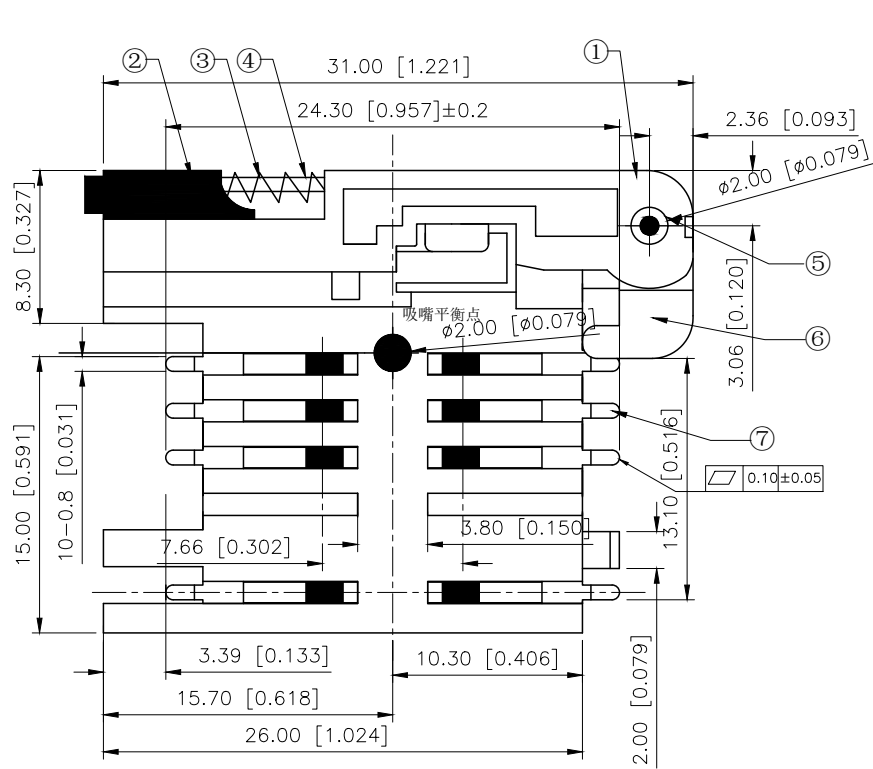
REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面, 产品结构变更	2024.11.9	阿树

A

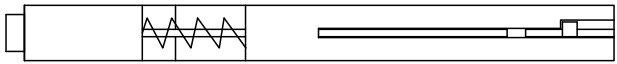
B

C

D



RECOMMENDED PCB LAYOUT ±0.05



7	Reeds	Phosphor bronze	8	Ni plating overall; Contact plating Au15u"
6	Z-shaped plates	SUS	1	
5	Small shafts	Phosphor bronze	1	
4	pushrod	SUS	1	
3	spring	SUS	1	
2	Button	LCP	1	
1	bracket	LCP	1	Wave soldering: The material is LCP
NO	NAME	MATERIAL	QTY	Remark

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN	阿树	VIEW:	MODEL TYPE: SIM CARD CONN
CHECKED		UNIT: mm/in	PART NO.: XKSIM-816-P6
APPROVED		SIZE: A4	DWG NO.:

